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## ABSTRACT OF THE DISCLOSURE

5 A semiconductor laser chip has an emission facet  
for emitting a laser beam. A sub-mount has a first  
surface and at least one second surface vertical to the  
first surface. The semiconductor laser chip is  
provided on the first surface of the sub-mount. The  
10 second surface arranged in line with the emission facet  
of the semiconductor laser chip is inclined at an angle  
of 3 to 30 degrees. The inclined second surface  
reflects reflection light of a sub-beam diffracted from  
a main beam emitted by the semiconductor laser chip.

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